

JMM4812N

Product Preview

30V N-Channel MOSFET



Features

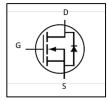
- Advanced shielded-gate technology
- Ultra-low on-resistance and gate-charge
- RoHS compliant
- 100% avalanche tested

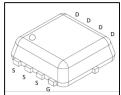


Product Summary				
V _{DS} 30V				
В	4.1mΩ (Typ.)			
R _{DS(ON)}	5.0mΩ (Max.)			

Applications

- Motor controllers
- DC-to-DC convertors
- Battery-driven electronic products, electrical equipment and machines





Ordering Information

Part Number Marking		Package	Packaging	
JMM4812N	MM4812N	DFN5x6	Tape & Reel	



Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Drain-to-Source Voltage	V _{DS}	30	V
Gate-to-Source Voltage	V _{GS}	±20	v
Continuous Drain Current (T _C = 25°C) ^{(1),(2)}	I _D	68	
Continuous Drain Current (T _C = 100°C) (1),(2)	I _D	43	
Continuous Drain Current (T _A = 25°C) (3),(4)	I _D	16	A
Continuous Drain Current (T _A = 100°C) (3),(4)	I _D	10	
Pulsed Drain Current (5)	I _{DM}	120	
Power Dissipation (T _C = 25°C)	P _D	37	W
Linear Derating Factor	-	0.29	W/°C
Single Pulse Avalanche Energy (6)	E _{AS}	29	mJ
Avalanche Current ⁽⁷⁾	I _{AS}	17	А
Junction Temperature	T,	-55 to 150	- °C
Storage Temperature	T _{STG}	-55 to 150	

Thermal Characteristics

Parameter	Symbol	Max	Unit
Junction-to-Ambient Thermal Resistance (4)	$R_{\theta JA}$	62	°C /\\
Junction-to-Case Thermal Resistance	$R_{\theta JC}$	3.4	°C/W

Static Electrical Characteristics (8)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Drain-to-Source Breakdown Voltage	BV _{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	30	-	1	V
Gate Threshold Voltage	V _{GS(TH)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	1.1	-	2.2	v
		$V_{DS} = 30V, V_{GS} = 0V$	-	-	1	μА
Drain-to-Source Leakage Current	I_{DSS}	$V_{DS} = 24V, V_{GS} = 0V,$			10	
		T _J = 125°C	-	-	10	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
Drain to Course On Desistance		$V_{GS} = 10V, I_D = 20A$	-	4.1	5.0	mΩ
Drain-to-Source On-Resistance	R _{DS(ON)}	$V_{GS} = 4.5 \text{ V, } I_D = 20 \text{A}$	-	6.5	8.0	mΩ



Dynamic Electrical Characteristics (8)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Forward Transconductance	g fs	$V_{DS} = 5V, I_{D} = 20A$	-	85	-	S
Total Gate Charge	Q _g	V _{GS} = 10V,	-	17.4	-	
Gate-to-Source Charge	Q _{gs}	V _{DS} = 15V,	-	3.4	-	nC
Gate-to-Drain Charge	Q_{gd}	I _D = 20A	-	3.1	-	
Turn-On Delay Time	t _{d(on)}	$V_{GS} = 10V$, $V_{DS} = 15V$, $I_D = 15A$, $R_G = 3.0\Omega$	-	7	-	
Rise Time	t _r		-	2.8	-	
Turn-Off Delay Time	t _{d(off)}		-	21.4	-	ns
Fall Time	t _f		-	5.3	-	
Input Capacitance	C _{iss}	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1MHz	-	960	-	
Output Capacitance	C _{oss}		-	410	-	pF
Reverse Transfer Capacitance	C _{rss}		-	60	-	

Diode Characteristics (8)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Forward Voltage	V _{SD}	$V_{GS} = 0V$, $I_S = 10A$	-	0.8	-	V
Reverse Recovery Time	T _{rr}	$V_{GS} = 0V$, $I_S = 20A$,	-	12.3	-	ns
Reverse Recovery Charge	Q _{rr}	$dI_s/dt = 100A/\mu s$	-	17.6	-	nC

- (1) Limited by package.
- (2) Rated according to $R_{\theta JC}$.
- (3) Rated according to $R_{\theta JA}. \label{eq:Relation}$
- (4) Surface–mounted on 1 inch² FR4 board, 2 oz Cu.
- (5) Limited by maximum $T_{\scriptscriptstyle J}$.
- (6) Starting T_J = 25°C, I_{AS} = 17A, L = 0.1mH, V_{DD} = 20V, V_{GS} = 10V
- (7) Pulse width limited by maximum $T_{\scriptscriptstyle J}$.
- (8) $T_J = 25$ °C unless otherwise specified.



Typical Electrical Characteristics

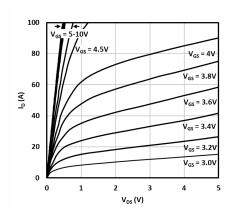


Fig. 1 Output characteristics

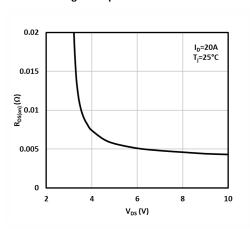


Fig.3 On-resistance vs. gate voltage

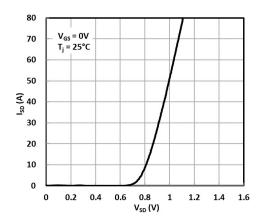


Fig.9 Source-to-drain diode forward characteristics

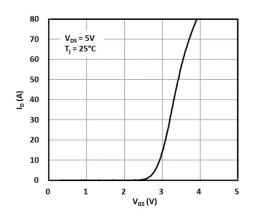


Fig. 2 Transfer characteristics

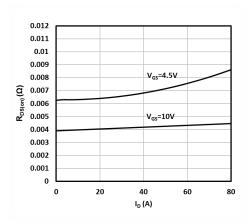


Fig.4 On-resistance vs. drain current

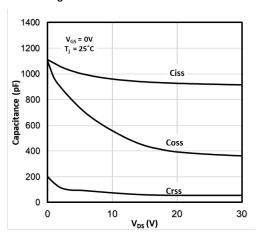


Fig.10 Capacitance vs. drain-to-source voltage



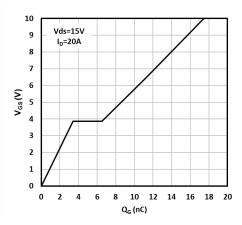


Fig.11 Gate-to-source voltage vs. gate charge

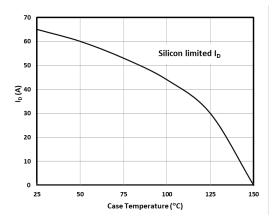


Fig.14 Maximum drain current vs. case temperature

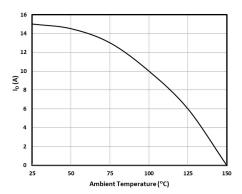
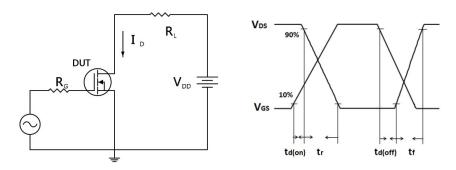


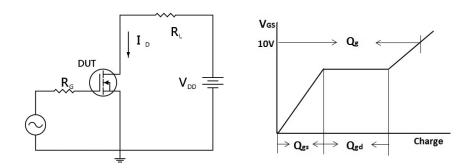
Fig.15 Maximum drain current vs. ambient temperature



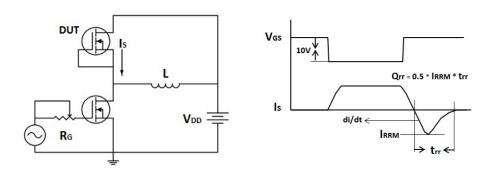
Test Circuits and Waveforms



Resistive switching time test circuit & waveforms

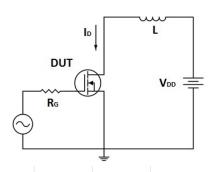


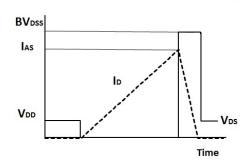
Gate charge test circuit & waveform



Peak diode recovery dv/dt test circuit & waveforms

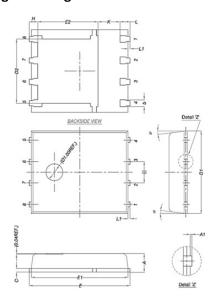






Unclamped inductive switching test circuit & waveforms

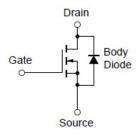
Package Drawing



544	MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0	-	0.05	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
Ε	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е		1.27 BSC		
Н	0.41	0.51	0.61	
K	1.10	-	-	
L	0.51	0.61	0.71	
L1	0.06	0.13	0.20	
α	0°	-	12°	

DFN 5x6

Equivalent Circuit





Revision history of JMM4812N Specification

Version	Change Items	Effective Date
1.00	Initial Release	29-Oct-20



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